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Form PTO-447A (Rev. 7-98) Staple to face of Application

U.S. DEPARTMENT OF COMMERCE PATENT & TRADEMARK OFFICE

APPLICATION TRANSFER REQUEST FOR S.N. 10080036

TO: Art Unit 2186 Class/sub 711/ FROM: A.U. 2185 Class REASON: Memory module packaging. Gatekeeper concurrence Section IIa. DISPOSITION BY RECEIVING TC By: BRAGDON, REGINALD GLENWOOD A.U. 2186 Date 6/28/2002 NOT ACCEPTED Forward to receiving TC Post Classifier	TAT I DIOTATE	
REASON: Memory module packaging. Gatekeeper concurrence Section IIa. DISPOSITION BY RECEIVING TC By: BRAGDON, REGINALD GLENWOOD A.U. 2186 Date 6728/2002 NOT ACCEPTED Forward to receiving TC Post Classifier REASON: Memory module packaging is not proper for class 711. There is no data processing in the claims for class 711. Section IIb. DISPOSITION BY RECEIVING TC POST CLASSIFIER This dispute was resolved. Forward to TC/AU This dispute was not resolved, forward to DISPUTE RESOLUTION PANEL Post Classifier Assessment: Gatekeeper concurrence Post Classifier Date Section III. DISPOSITION BY DISPUTE RESOLUTION PANEL Panel Decision: Forward To Technology Center/Art Unit Class/sub Concurring Panel Member	Section I. TRANSFER REQUEST BY	Name HO, HOAI V Date 5/24/2002
Memory module packaging. Section IIa. DISPOSITION BY RECEIVING TC By: BRAGDON, REGINALD GLENWOOD (a.U. 2186) Date 6728/2002 NOT ACCEPTED Forward to receiving TC Post Classifier REASON: Memory module packaging is not proper for class 711. There is no data processing in the claims for class 711. Section IIb. DISPOSITION BY RECEIVING TC POST CLASSIFIER This dispute was resolved. Forward to TC/AU 28/11 Class/Sub 25/2 Post Classifier Date Memory module appears proper for class 724. This dispute was not resolved, forward to DISPUTE RESOLUTION PANEL Post Classifier Assessment: Gatekeeper concurrence Post Classifier Date Section III. DISPOSITION BY DISPUTE RESOLUTION PANEL Panel Decision: Forward To Technology Center/Art Unit Class/Sub / Cancurring Panel Member	TO: Art Unit 2186 Class/sub 711/	FROM: A.U. 2185 Class
Section IIa. DISPOSITION BY RECEIVING TC By: BRAGDON, REGINALD GLENWOOD A.U. 2186 Date 6728/2002 NOT ACCEPTED Forward to receiving TC Post Classifier REASON: Memory module packaging is not proper for class 711. There is no data processing in the claims for class 711. Section IIb. DISPOSITION BY RECEIVING TC POST CLASSIFIER This dispute was resolved. Forward to TC/AU 2811 Class/Sub 257 Post Classifier Date Memory module approar for Class 724 This dispute was not resolved, forward to DISPUTE RESOLUTION PANEL Post Classifier Assessment: Gatekeeper concurrence Post Classifier Date Section III. DISPOSITION BY DISPUTE RESOLUTION PANEL Panel Decision: Forward To Technology Center/Art Unit Concurring Panel Member	REASON: Memory module packaging.	
NOT ACCEPTED Forward to receiving TC Post Classifier REASON: Memory module packaging is not proper for class 711. There is no data processing in the claims for class 711. Section IIb. DISPOSITION BY RECEIVING TC POST CLASSIFIER This dispute was resolved. Forward to TC/AU 28/1 Class/Sub 257/ Post Classifier Date This dispute was not resolved, forward to DISPUTE RESOLUTION PANEL Post Classifier Assessment: Gatekeeper concurrence Post Classifier Date Section III. DISPOSITION BY DISPUTE RESOLUTION PANEL Panel Decision: Forward To Technology Center/Art Unit Class/sub / Concurring Panel Member	Gatekeeper concurrence	
REASON: Memory module packaging is not proper for class 711. There is no data processing in the claims for class 711. Section IIb. DISPOSITION BY RECEIVING TC POST CLASSIFIER This dispute was resolved. Forward to TC/AU 28/11 Class/Sub 257! Post Classifier Date Memory module appears proper for class 711. This dispute was not resolved, forward to DISPUTE RESOLUTION PANEL Post Classifier Assessment: Gatekeeper concurrence Post Classifier Date Section III. DISPOSITION BY DISPUTE RESOLUTION PANEL Panel Decision: Forward To Technology Center/Art Unit Concurring Panel Member Concurring Panel Member	Section IIa. DISPOSITION BY RECEIVING	G TC By: BRAGDON, REGINALD GLENWOOD A.U. 2186 Date 6/28/2002
Memory module packaging is not proper for class 711. There is no data processing in the claims for class 711. Section IIb. DISPOSITION BY RECEIVING TC POST CLASSIFIER This dispute was resolved. Forward to TC/AU 28/1 Class/Sub 257/ Post Classifier Date Memory module appears proper for class 712. Memory module appears proper for class 711. This dispute was not resolved, forward to DISPUTE RESOLUTION PANEL Post Classifier Assessment: Gatekeeper concurrence Post Classifier Date Section III. DISPOSITION BY DISPUTE RESOLUTION PANEL Panel Decision: Forward To Technology Center/Art Unit Class/sub / Concurring Panel Member	NOT ACCEPTED Forward to receiving TC Post C	lassifier
Post Classifier Assessment: Gatekeeper concurrence Date Section III. DISPOSITION BY DISPUTE RESOLUTION PANEL Date Panel Decision: Forward To Technology Center/Art Unit Class/sub/ REASON: Concurring Panel Member	REASON: Memory module packaging is not proper for class 711. There is no data processing in the claims for class 711.	
Post Classifier Assessment: Gatekeeper concurrence Date Section III. DISPOSITION BY DISPUTE RESOLUTION PANEL Date Panel Decision: Forward To Technology Center/Art Unit Class/sub/ REASON: Concurring Panel Member	Section IIb. DISPOSITION BY RECEIVING TC POST CLASSIFIER This dispute was resolved. Forward to TC/AU 2811 Class/Sub 257! Post Classifier Date Memory module appears proper for cl 757 Concurring This dispute was not resolved, forward to DISPUTE RESOLUTION PANEL	
Panel Decision: Forward To Technology Center/Art Unit Class/sub/ REASON: Concurring Panel Member	Post Classifier Assessment:	
REASON: Concurring Panel Member	Section III. DISPOSITION BY DISPUTE RESOLUTION PANEL Date	
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